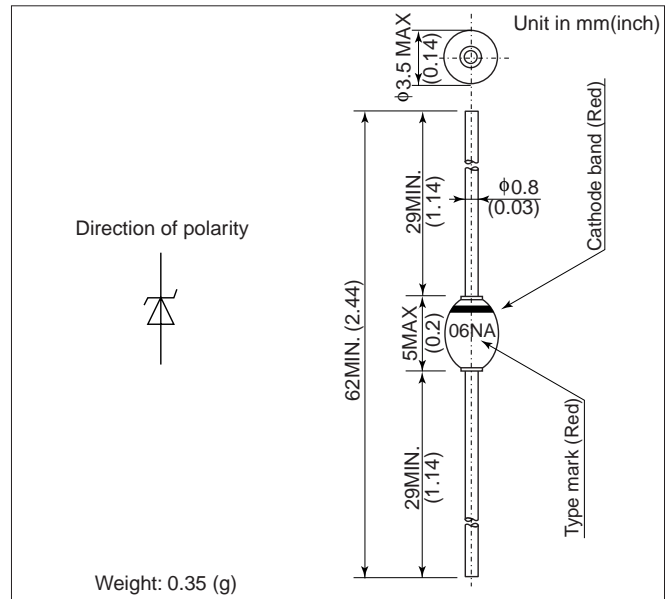


**FEATURES**

- For stabilized power supply.
- Diffused-junction. Glass passivated and encapsulated.

**OUTLINE DRAWING****ABSOLUTE MAXIMUM RATINGS**

Items	Symbols	Units	Ratings
Permissible Power Dissipation	P	W	1.0
Operating Junction Temperature	$T_j$	$^{\circ}\text{C}$	-40 ~ +150
Storage Temperature	$T_{\text{stg}}$	$^{\circ}\text{C}$	-40 ~ +150
Maximum Permissible Current	$I_{ZM}$	mA	Refer to characteristics column
Non-Repetitive Peak Reverse One-Cycle Dissipation	$P_{\text{RSM}}$	Wp	80

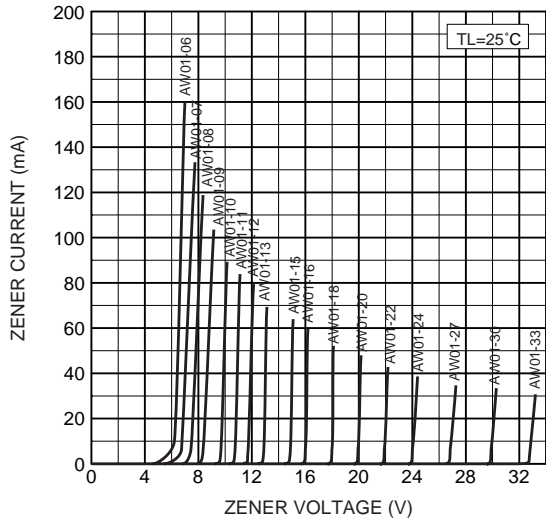
- Notes (1) Lead mounting : Lead temperature 300 $^{\circ}\text{C}$  max. to 3.2mm from body for 5sec. max..  
 (2) Mechanical strength : Bending 90 $^{\circ}$ ×2 cycles or 180 $^{\circ}$ ×1 cycle, Tensile 2kg, Twist 90 $^{\circ}$ ×1 cycle.

**CHARACTERISTICS( $T_L=25^{\circ}\text{C}$ )**

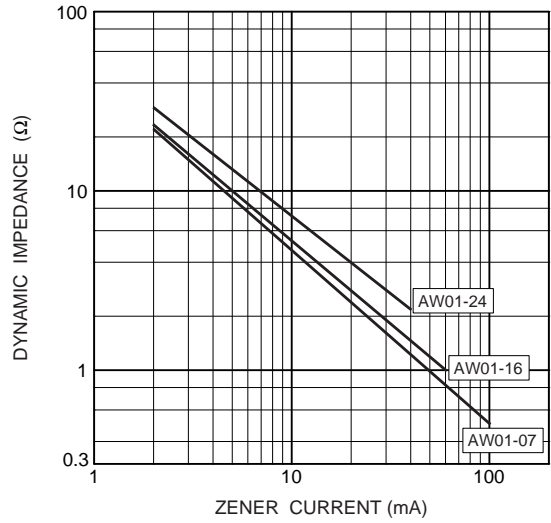
Type	Characteristics				Maximum Permissible Current (TL=100 $^{\circ}\text{C}$ ) (L=10mm) $I_{ZM}$ (mA)	Typical Zener Voltage Temperature Coefficient $\gamma_Z$ (%/ $^{\circ}\text{C}$ )
	Zener Voltage $V_Z$ (V)		Maximum Dynamic Impedance $Z_z$ (ohm)	Test Current $I_Z$ (mA)		
	Minimum	Maximum				
AW01-06	5.2	6.8	9	60	160	0.025
AW01-07	6.2	7.9	7	25	135	0.035
AW01-08	7.7	8.7	3	25	120	0.045
AW01-09	8.5	9.6	3	25	105	0.053
AW01-10	9.4	10.6	5	25	95	0.058
AW01-11	10.4	11.6	5	25	85	0.063
AW01-12	11.4	12.7	8	25	75	0.065
AW01-13	12.4	14.1	8	25	70	0.068
AW01-15	13.5	15.6	12	15	65	0.072
AW01-16	15.3	17.1	12	15	60	0.074
AW01-18	16.8	19.1	15	15	52	0.076
AW01-20	18.8	21.2	15	15	48	0.078
AW01-22	20.8	23.3	15	15	43	0.080
AW01-24	22.7	25.6	15	10	40	0.081
AW01-27	25.1	28.9	15	10	35	0.082
AW01-30	28.0	32.0	15	10	32	0.083
AW01-33	31.0	35.0	15	10	30	0.084

# AW01

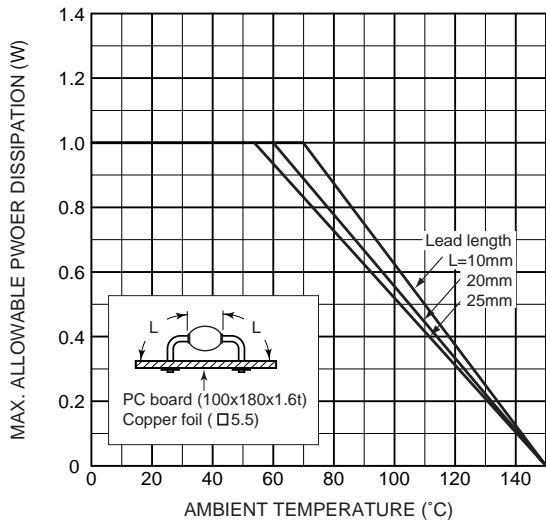
Typical zener characteristics



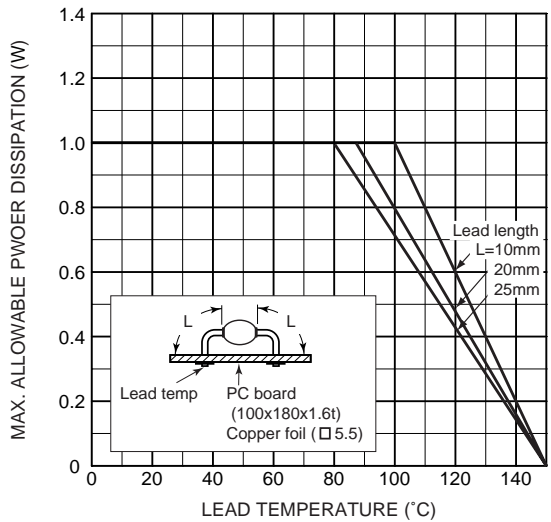
Typical dynamic impedance vs. zener current



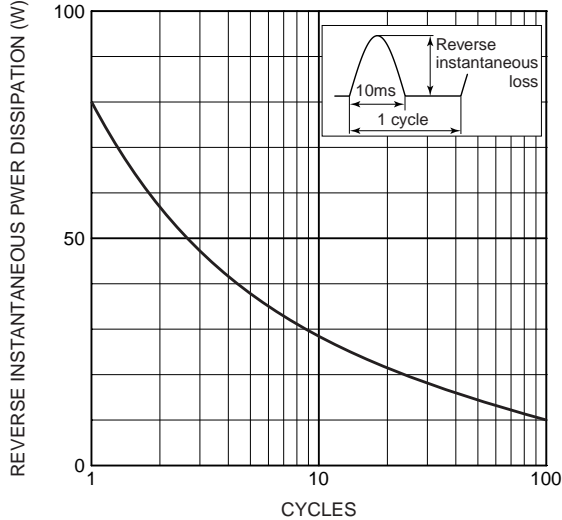
Max. allowable power dissipation vs. ambient temperature



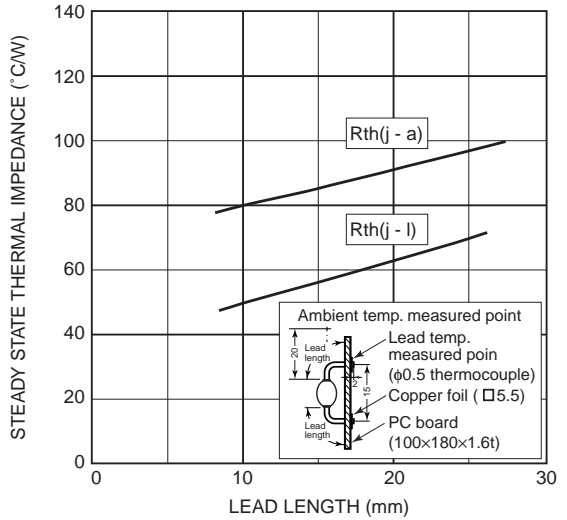
Max. allowable power dissipation vs. lead temperature



Reverse power characteristic (Non-repetitive)

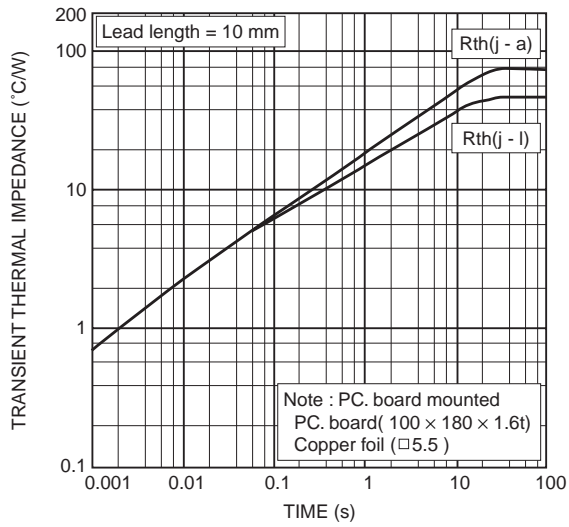


Steady state thermal impedance

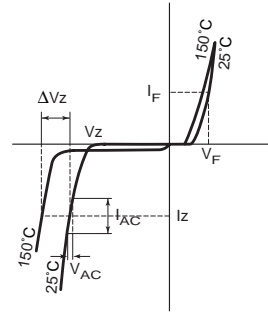


# AW01

## Transient thermal impedance



## Definition of zener characteristics



- $\Delta V_Z$ : Zener voltage change
  - $V_Z$ : Zener voltage (Test current  $I_Z$ )
  - $I_Z$ : Test current
  - $Z_Z$ : Dynamic impedance =  $V_{AC} / I_{AC}$
  - $I_F$ : Forward current
  - $V_F$ : Forward voltage drop
  - $\gamma_Z$ : Zener voltage average temperature coefficients
- $$= \frac{\Delta V_Z}{V_Z} \times \frac{1}{(150-25)} \times 100$$

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